



PATENT
81784.0301

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Mitsuru OKIGAWA

Serial No: 10/773,088

Filed: February 5, 2004

For: SEMICONDUCTOR INTEGRATED
DEVICE INCLUDING SUPPORT
SUBSTRATE FASTENED USING RESIN,
AND MANUFACTURING METHOD
THEREOF

Art Unit: 2824

Examiner: Luhrs, M. K.

I hereby certify that this correspondence
is being deposited with the United States
Postal Service with sufficient postage as
first class mail in an envelope addressed
to:

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450, on
May 9, 2005

Date of Deposit

John P. Scherlacher, Reg. No. 23,009

Name

Signature *John P. Scherlacher* 05/09/05

Signature

Date

STATUS REQUEST

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This application was filed on February 5, 2004 and receipt acknowledged by the Patent Office in that the postcard was returned with the application serial number 10/773,088. An official filing receipt was received from the Patent Office on August 12, 2004, and the Notice Of Recordation Of Assignment Document. No further papers have been received in this case.

Please send the undersigned a Status Report on this application.

Respectfully submitted,
HOGAN & HARTSON L.L.P.

Date: May 9, 2005

By:

John P. Scherlacher
John P. Scherlacher
Registration No. 23,0009
Attorney for Applicant(s)

500 South Grand Avenue Suite 1900
Los Angeles, California 90071
Telephone: 213 337-6700
Facsimile: 213 337-6701